

1N5807/US, 1N5809/US, 1N5811/US

ULTRAFAST RECOVERY RECTIFIERS

TECHNICAL DATA DATA SHEET 127, REV. H.5

AVAILABLE AS

1N, JAN, JANTX, JANTXV

JANS

JAN EQUIVALENT*

SJ*, SX*, SV*, SS*

Ultrafast Recovery Rectifiers

Qualified per MIL-PRF-19500/477

DESCRIPTION:

This voidless hermetically sealed ultrafast recovery rectifier diode series is military qualified per Mil-PRF-19500/477 and is targeted for commercial and military aircraft, military vehicles, shipboard markets, space and all other high reliability applications.

FEATURES / BENEFITS:

- ✓ Hermetic, non-cavity glass package
- ✓ Category I Metallurgically bonded
- ✓ All devices are 100% hot solder dipped
- ✓ JAN/ JANTX/JANTXV available per MIL-PRF-19500/477
- ✓ "JANS Plus" removes atypical/out of family V_F

MAXIMUM RATINGS

- ✓ Operating and Storage Temperature: -65°C to +175°C
- ✓ Thermal Resistance: 22 °C (junction to lead)
- ✓ Thermal Resistance: 6.5 °C (junction to endcap)
- ✓ Forward surge current:125A @ 8.3 ms half-sine

ELECTRICAL CHARACTERISTICS

TYPE NUMBER	WORKING PEAK REVERSE VOLTAGE	AVG RECTIFIED CURRENT ¹	MAXIMUM REVERSE CURRENT @ PIV		MAX. PEAK FORWARD VOLTAGE (PULSED)	MAXIMUM SURGE CURRENT ² I _{FSM}	MAXIMUM REVERSE RECOVERY TIME ³	
		Amps	μ A n	nps	V _F @ 1A		T_{rr}	
	Volts	55°C	25°C	125°C	V	Amps	nsec	
1N5807/US 1N5809/US 1N5811/US	50 100 150	6.0	5	525	.875	125	30	

Note 1: $T_{EC} = T_L$ at L=0 or $T_{end \ tab}$ f or US suffix devices. Derate at $60 \text{mA}/^{\circ}\text{C}$ for T_L above $75 ^{\circ}\text{C}$.

Note 2: $I_0 = 3A$, 8.3ms surge

Note 3: $I_F=1A$, $I_{RM}=1A$, $I_{R(REC)}=.10A$

*Sensitron **space equivalent diodes** are manufactured and screened to MIL-PRF-19500 flow and guidelines starting from wafer fabrication through assembly and testing using our internal specification.

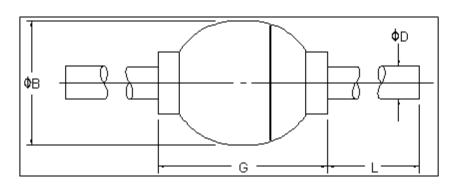


ULTRAFAST RECOVERY RECTIFIERS

TECHNICAL DATA DATA SHEET 127, REV. H.4

PACKAGE DIMENSIONS (inches/mm)

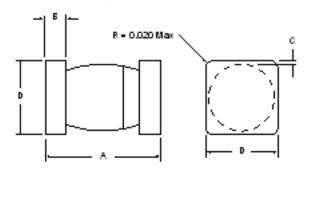
AXIAL



PACKAGE			DIMENSIONS - INCHES (MILLIMETERS)					_	
STYLE			фΒ		φD	G	L		
	304		115/.142 !.92/3.61		.036/.042 .94/1.07	.130/.300 3.30/7.62	.90/1.30 22.9/33.0	Γ	

MELF (Add "US" to Part Number)

MELF PACKAGE OUTLINES



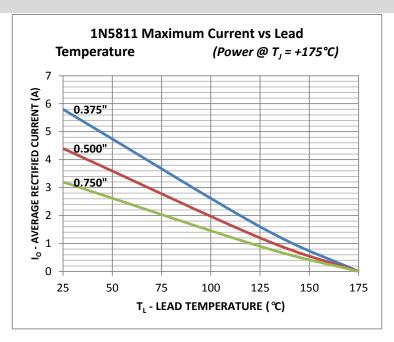


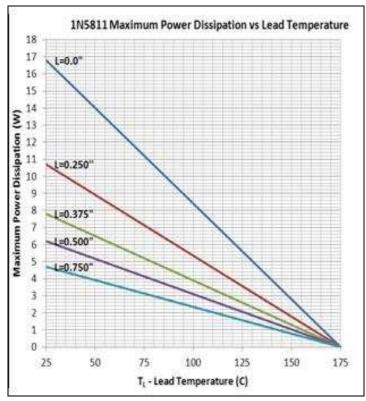
PACKAGE **DIMENSIONS - INCHES / MILLIMETERS** STYLE А В С D MELF-B .2007.225 0.019/.028 .003 Min .137/.148 5.0/5.8 .48/.72 .076 Min 3.4/3.8

ULTRAFAST RECOVERY RECTIFIERS

TECHNICAL DATA DATA SHEET 127, REV. H.4

GRAPHS:







1N5807/US, 1N5809/US, 1N5811/US

ULTRAFAST RECOVERY RECTIFIERS

TECHNICAL DATA DATA SHEET 127, REV. H.4

PART ORDERING INFORMATION

The following part numbers can be purchased in either axial or surface mount devices and screened and tested to the military screening flow. The parts are marked in accordance with the testing performed, example:

*Available with silver leads (SS5811-AG).

		Tivaliable with silver leads (eccert Tia)
Sensitron Screening Level	*Part Number Leaded Package (example for 1N5811)	*Part Number Surface Mount Package (example for 1N5811US)
1N	1N5811	1N5811US
JAN	JAN1N5811	JAN1N5811US
JANTX	JANTX1N5811	JANTX1N5811US,
JANTXV	JANTXV1N5811	JANTXV1N5811US
SJ	SJ5811	SJ5811US
SX	SX5811	SX5811US
sv	SV5811	SV5811US
JANS	JANS1N5811	JANS1N5811US
SS	SS5811	SS5811US

DISCLAIMER:

- 1- The information given herein, including the specifications and dimensions, is subject to change without prior notice to improve product characteristics. Before ordering, purchasers are advised to contact the Sensitron Semiconductor sales department for the latest version of the datasheet(s).
- 2- In cases where extremely high reliability is required (such as use in nuclear power control, aerospace and aviation, traffic equipment, medical equipment, and safety equipment), safety should be ensured by using semiconductor devices that feature assured safety or by means of users' fail-safe precautions or other arrangement.
- 3- In no event shall Sensitron Semiconductor be liable for any damages that may result from an accident or any other cause during operation of the user's units according to the datasheet(s). Sensitron Semiconductor assumes no responsibility for any intellectual property claims or any other problems that may result from applications of information, products or circuits described in the datasheets.
- 4- In no event shall Sensitron Semiconductor be liable for any failure in a semiconductor device or any secondary damage resulting from use at a value exceeding the absolute maximum rating.
- 5- No license is granted by the datasheet(s) under any patents or other rights of any third party or Sensitron Semiconductor.
- 6- The datasheet(s) may not be reproduced or duplicated, in any form, in whole or part, without the expressed written permission of Sensitron Semiconductor.
- 7- The products (technologies) described in the datasheet(s) are not to be provided to any party whose purpose in their application will hinder maintenance of international peace and safety nor are they to be applied to that purpose by their direct purchasers or any third party. When exporting these products (technologies), the necessary procedures are to be taken in accordance with related laws and regulations.